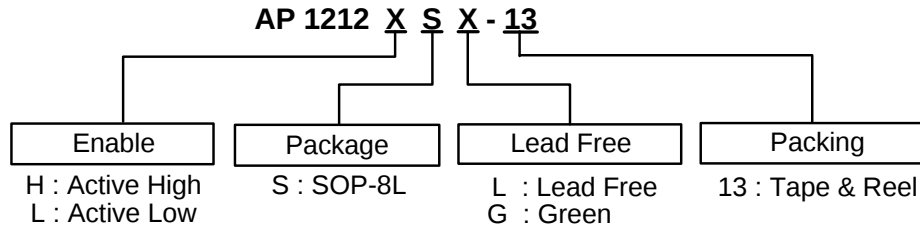


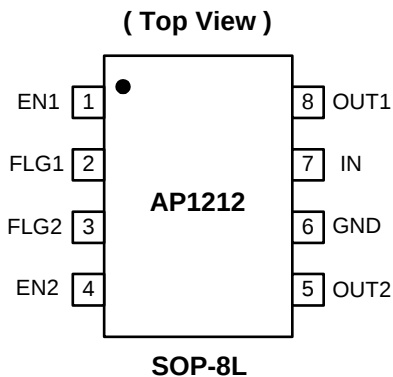
Ordering Information



Device	Package Code	Packaging (Note 2)	13" Tape and Reel	
			Quantity	Part Number Suffix
AP1212XSL-13	S	SOP-8L	2500/Tape & Reel	-13
AP1212XSG-13	S	SOP-8L	2500/Tape & Reel	-13

Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at http://www.diodes.com/products/lead_free.html.
2. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.

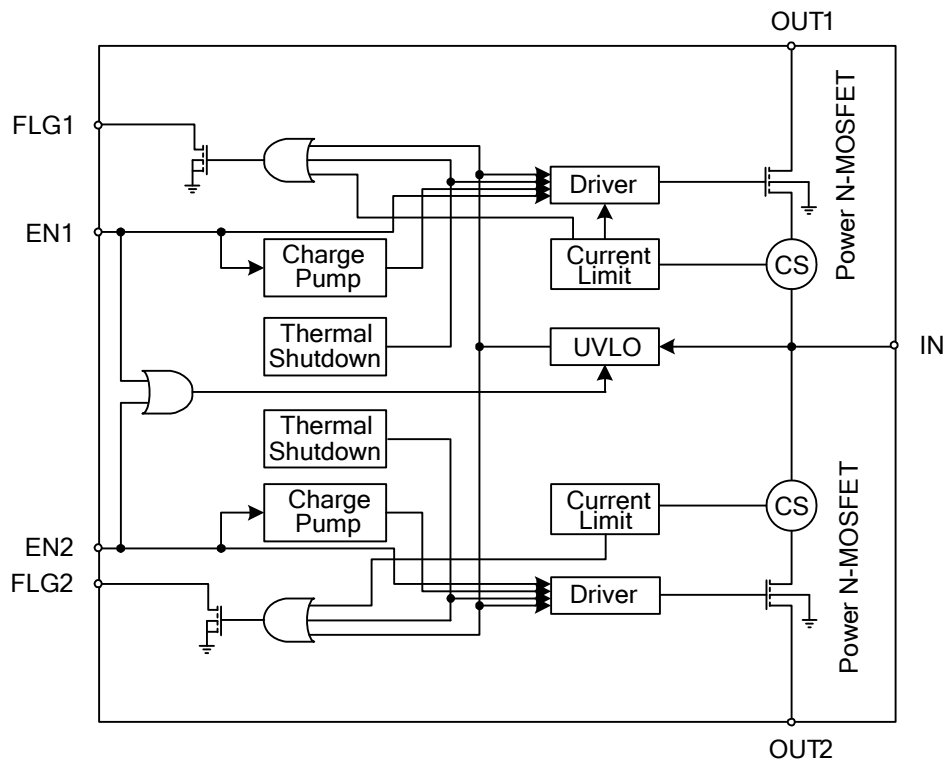
Pin Assignments



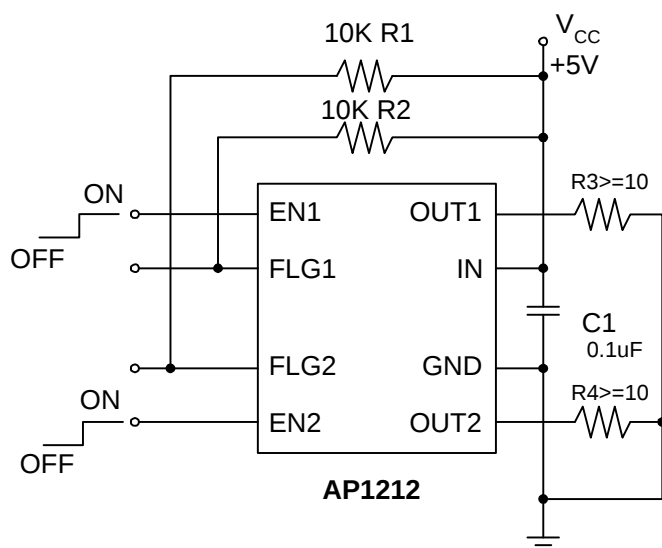
Pin Descriptions

Pin Name	Description
EN1 EN2	Enable: Logic-compatible enable input. (H: active high, L: active low). Do not float.
FLG1 FLG2	Fault Flag: Active-low, open-drain output. Indicates over current, UVLO, and thermal shutdown.
GND	Supply return.
IN	Supply Input: Output MOSFET drain. Also supplies IC's internal circuitry. Connect to positive supply.
OUT1 OUT2	Switch Output: Output MOSFET source. Typically connect to switched side of load.

Block Diagram



Test Circuit (Note 3)



Notes: 3. Before EN is asserted, a delay of 10ms minimum from when the supply voltage, Vcc, becomes stable must be allowed.

Absolute Maximum Ratings (Note 4)

Symbol	Parameter	Rating	Unit
ESD HBM	Human Body Model ESD Protection (Note 5)	500	V
ESD MM	Machine Model ESD Protection (Note 5)	150	V
V_{IN}	Supply Voltage	+7	V
V_{FLG}	Fault Flag Voltage	+7	V
I_{FLG}	Fault Flag Current	50	mA
V_{OUT}	Output Voltage	+7	V
V_{EN}	Control Input Range	-0.3 to $V_{IN} + 2$	V
T_{ST}	Storage Temperature	-65 to +150	°C
MSL	Moisture Sensitivity Level	3	-

Recommended Operating Conditions (Note 6)

Symbol	Parameter	Min	Max	Unit
V_{IN}	Supply Voltage	2.7	5.5	V
T_A	Operating Ambient Temperature	-40	125	°C

Notes:

- Exceeding the absolute maximum rating may damage the device.
- Devices are ESD sensitive. Handling precautions are recommended. Human Body model, tested per JEDEC 22-A114. Machine model, tested per JEDEC 22-A115.
- The device is not guaranteed to function outside its operating rating.

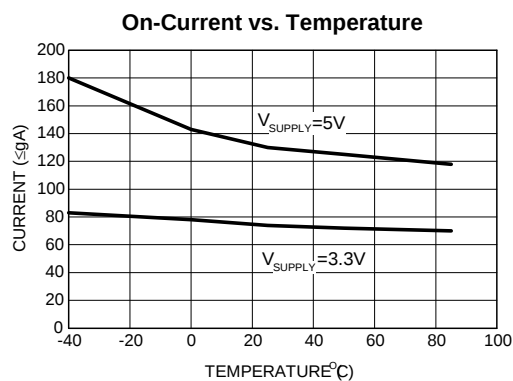
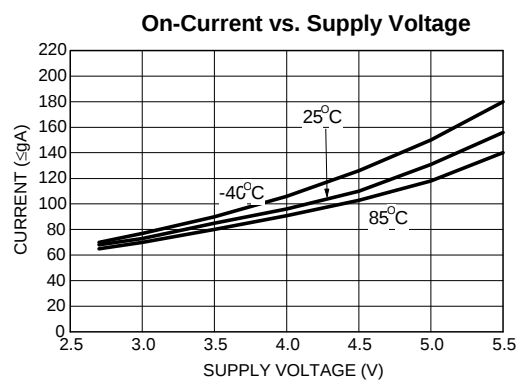
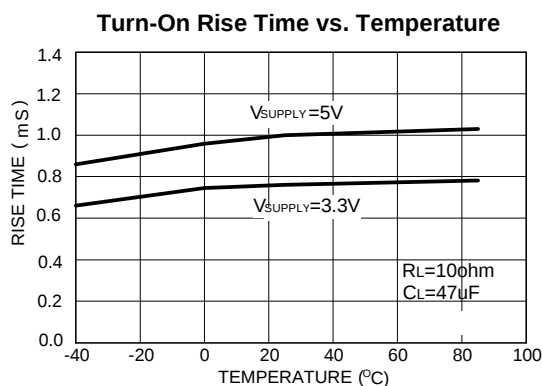
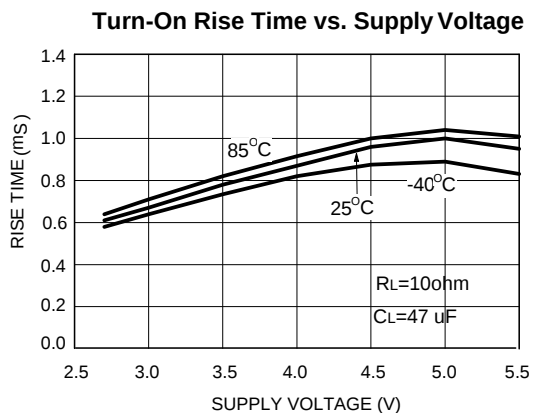
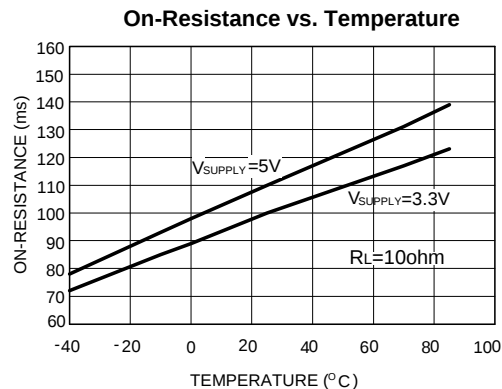
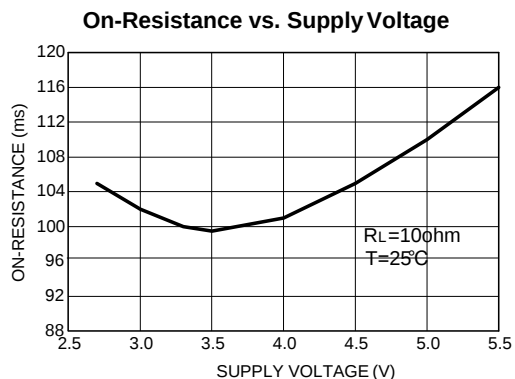
Electrical Characteristics

(Under the conditions of $V_{IN}=+5V$ and $T_A=25^{\circ}C$, unless otherwise specified)

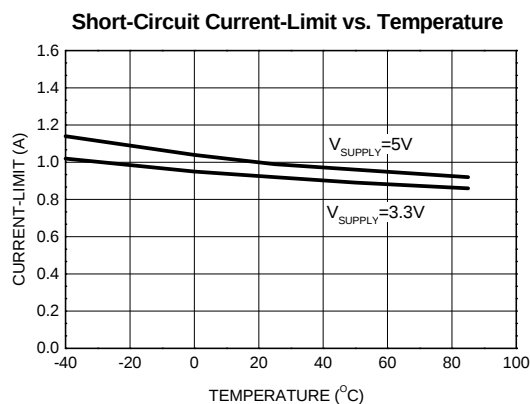
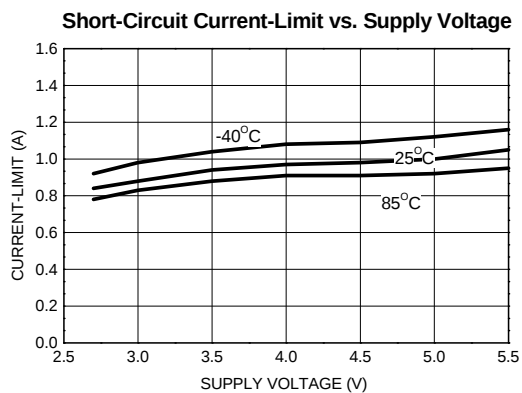
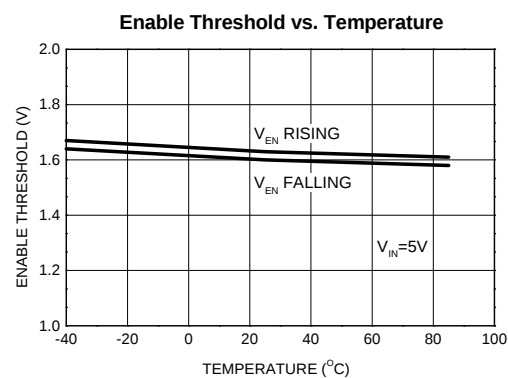
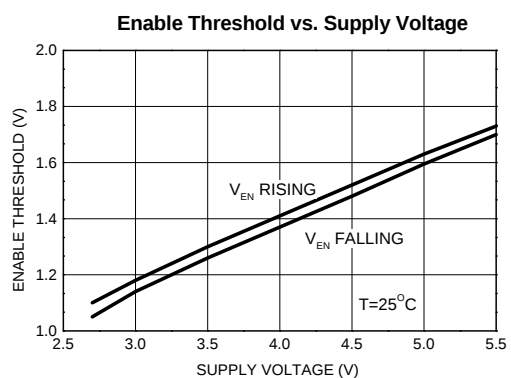
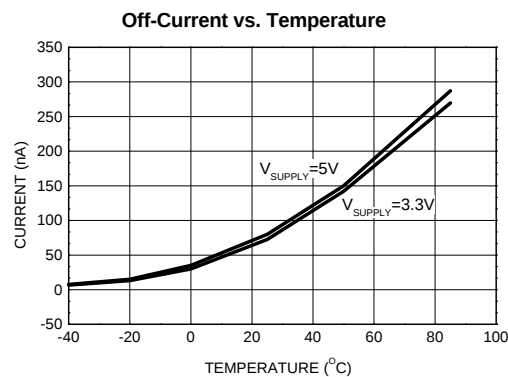
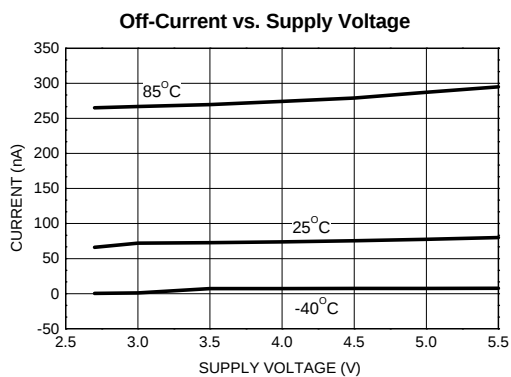
Symbol	Parameter	Conditions	Min	Typ.	Max	Unit
I_{CC}	Supply Current	Switch off, OUT = open (Note 7)		0.50	5	μA
		All switches on, OUT = open (Note 7)		110	160	μA
V_{IT}	Enable Input Threshold	(Note 7)	0.8	1.7	2.40	V
I_{EN}	Enable Input Current	$V_{EN} = 0V$ to 5.5V	-1	± 0.01	1	μA
C_{EN}	Enable Input Capacitance			1		pF
$R_{DS(ON)}$	Switch Resistance	$V_{IN} = 2.7V \sim 5.5V$, $I_{OUT} = 500mA$, each switch		110	140	m Ω
T_{OND}	Output Turn-On Delay	$R_L = 10\Omega$ each output		30		μS
T_R	Output Turn-On Rise Time	$R_L = 10\Omega$ each output		1		mS
T_{OFFD}	Output Turnoff Delay	$R_L = 10\Omega$ each output		0.5	10	μS
T_F	Output Turnoff Fall Time	$R_L = 10\Omega$ each output		0.5	10	μS
I_{LEAK}	Output Leakage Current	Each output (output disabled)			10	μA
I_{OUT}	Continuous Load Current	Each output	0.6			A
I_{OS}	Short-circuit Current Limit	Each output (enable into load), $V_{OUT} = 0V$	0.8	1.0	1.25	A
I_{LIM}	Current-Limit Threshold	Ramped load applied to enabled output	1.0	1.2	1.4	A
T_{TS}	Over-temperature Shutdown Threshold	T_J increasing		140		$^{\circ}C$
		T_J decreasing		130		$^{\circ}C$
R_{FO}	Error Flag Output Resistance	$V_{IN} = 5V$, $I_L = 10mA$		10	25	Ω
		$V_{IN} = 3.3V$, $I_L = 10mA$		15	40	Ω
I_{FOH}	Error Flag Off Current	$V_{FLAG} = 5V$		0.01	1	μA
UVLO	UVLO Threshold	$V_{IN} =$ increasing		2.5		V
		$V_{IN} =$ decreasing		2.3		V
θ_{JA}	Thermal Resistance Junction-to-Ambient	SOP-8L		165		$^{\circ}C/W$
θ_{JC}	Thermal Resistance Junction-to-Case	SOP-8L		26		$^{\circ}C/W$

Notes: 7. Off is $V_{EN} \leq 0.8V$ and on is $V_{EN} \geq 2.4V$ for the AP1212H. Off is $V_{EN} \geq 2.4V$ and on is $V_{EN} \leq 0.8V$ for the AP1212L.

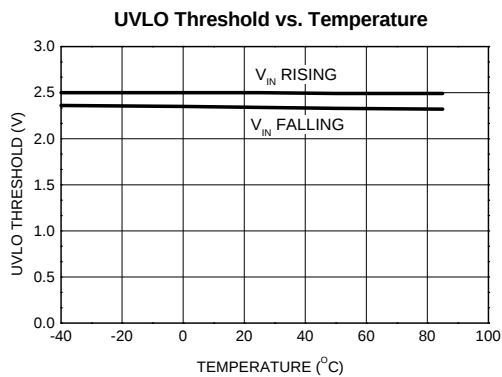
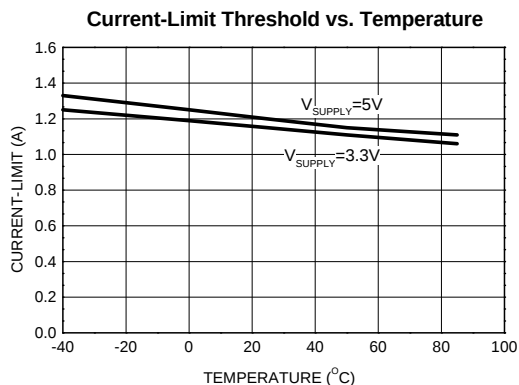
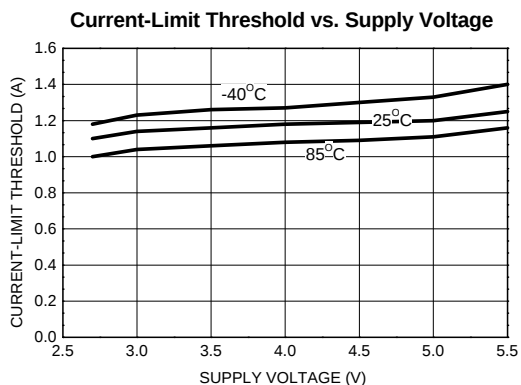
Typical Performance Characteristics



Typical Performance Characteristics (Continued)

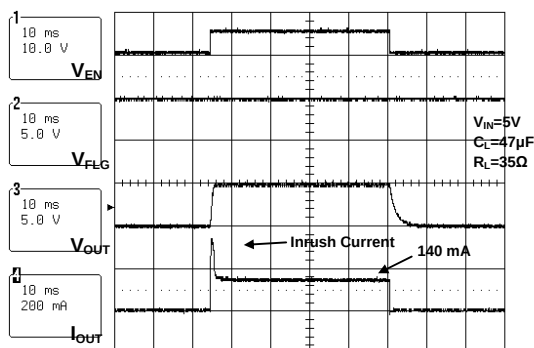


Typical Performance Characteristics (Continued)



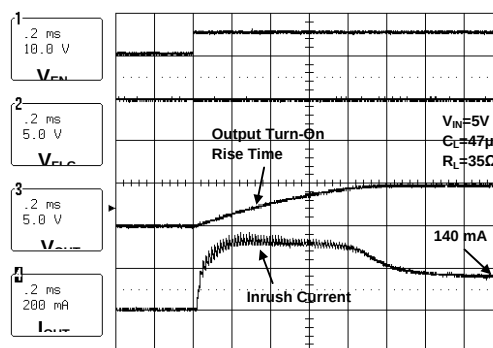
Typical Performance Characteristics (Continued)

Turn-On/Turn-Off (AP1212H)



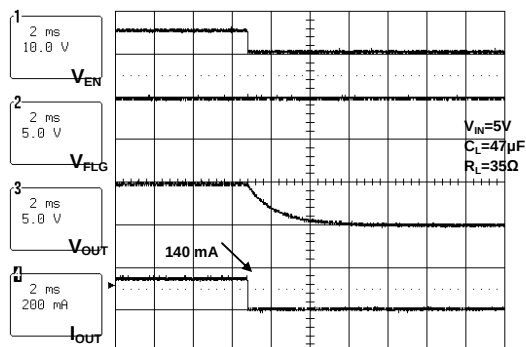
TIME (10ms/div.)

Turn-On (AP1212H)



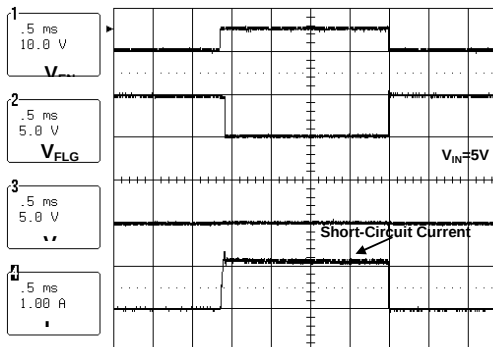
TIME (200μS/div.)

Turn-Off (AP1212H)



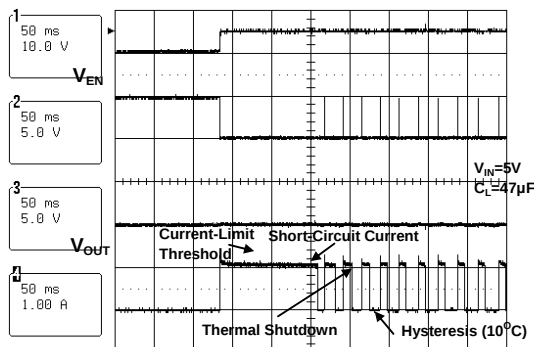
TIME (2ms/div.)

Enabled Into Short (AP1212H)



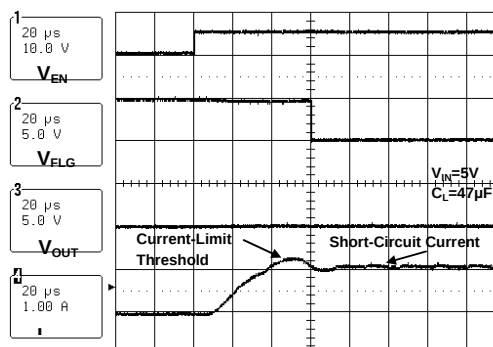
TIME (500μS/div.)

Current-Limit Response (AP1212H)



TIME (50ms/div.)

Current-Limit Response (AP1212H)



TIME (20μS/div.)

Functional Description

Error Flag

An open-drained output of N-channel MOSFET, the FLG output is pulled low to signal the following fault conditions: input under voltage, output current limit, and thermal shutdown.

Current Limit

The current limit threshold is preset internally. It protects the output MOSFET switches from damage due to undesirable short circuit conditions or excess inrush current often encountered during hot plug-in. The low limit of the current limit threshold of the AP1212 allows a minimum current of 0.5A through the MOSFET switches. A current limit condition will signal the error flag.

Thermal Shutdown

When the chip temperature exceeds 140°C for any reason other than over current fault of either one of the two MOSFET switches, the thermal shutdown function turns off both MOSFET switches and signals the error flag. A hysteresis of 10°C prevents the MOSFETs from turning back on until the chip temperature drops to below 130°C.

Enable

Before EN is asserted, a delay of 10ms minimum from when the supply voltage, Vcc, becomes stable must be allowed.

Supply Filtering

A 0.1μF to 1μF bypass capacitor from IN to GND, located near the device, is strongly recommended to control supply transients. Without a bypass capacitor, an output short may cause sufficient ringing on the input (from supply lead inductance) to damage internal control circuitry.

Transient Droop Requirements

USB applications support dynamic attachment (hot plug-in) of peripherals. A current surge is caused by the input capacitance of downstream device. Ferrite beads are recommended in series with all power and ground connector pins. Ferrite beads reduce EMI and limit the inrush current during hot-attachment by filtering high-frequency signals.

Short Circuit Transient

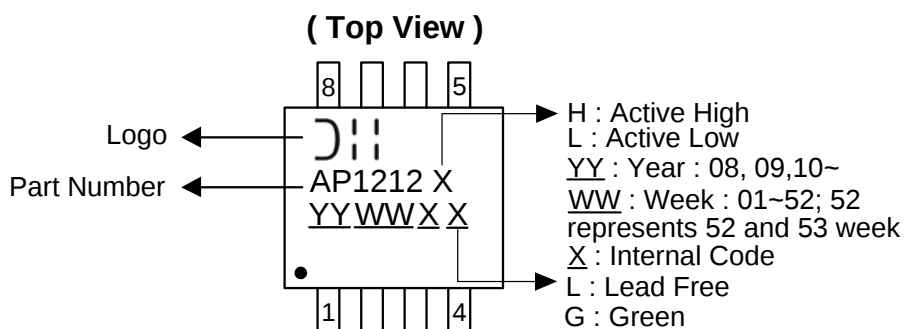
Bulk capacitance provides the short-term transient current needed during a hot-attachment event. With a 33μF, 16V tantalum or 100μF, 10V electrolytic capacitor mounted close to downstream connector per port should provide transient drop protection.

Printed Circuit Layout

The power circuitry of USB printed circuit boards requires a customized layout to maximize thermal dissipation and to minimize voltage drop and EMI.

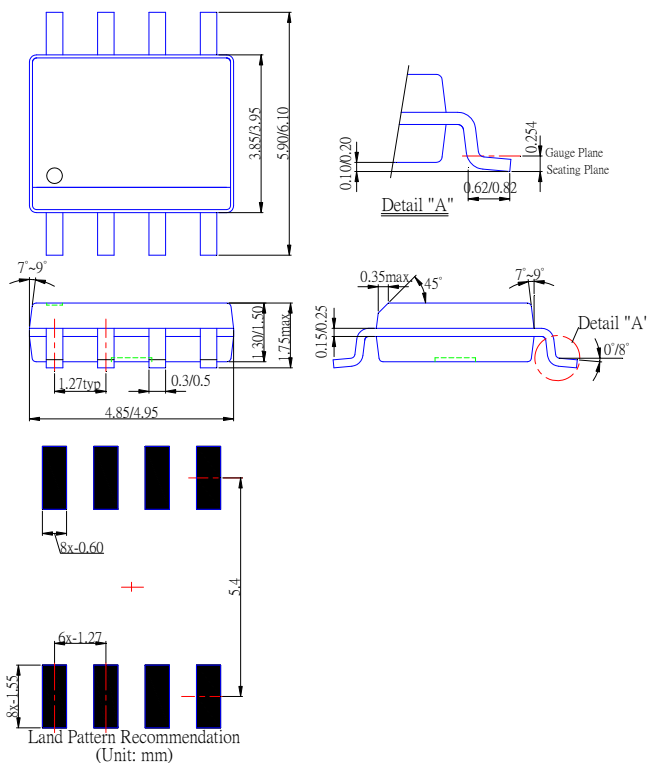
Marking Information

(1) SOP-8L



Package Information (All Dimensions in mm)

(1) Package Type: SOP-8L



IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.

Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or
2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2009, Diodes Incorporated

www.diodes.com